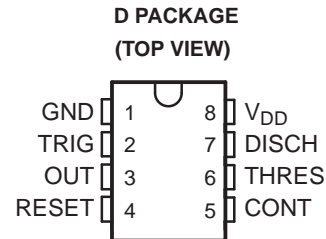


## FEATURES

- **Qualified for Automotive Applications**
- **Very Low Power Consumption**  
– 1 mW Typ at  $V_{DD} = 5\text{ V}$
- **Capable of Operation in Astable Mode**
- **CMOS Output Capable of Swinging Rail to Rail**
- **High Output-Current Capability**  
– Sink 100 mA Typ  
– Source 10 mA Typ
- **Output Fully Compatible With CMOS, TTL, and MOS**
- **Low Supply Current Reduces Spikes During Output Transitions**
- **Single-Supply Operation From 2 V to 15 V**
- **Functionally Interchangeable With the NE555; Has Same Pinout**



## DESCRIPTION/ORDERING INFORMATION

The TLC555 is a monolithic timing circuit fabricated using the TI LinCMOS™ process. The timer is fully compatible with CMOS, TTL, and MOS logic and operates at frequencies up to 2 MHz. Because of its high input impedance, this device uses smaller timing capacitors than those used by the NE555. As a result, more accurate time delays and oscillations are possible. Power consumption is low across the full range of power supply voltage.

Like the NE555, the TLC555 has a trigger level equal to approximately one-third of the supply voltage and a threshold level equal to approximately two-thirds of the supply voltage. These levels can be altered by use of the control voltage terminal (CONT). When the trigger input (TRIG) falls below the trigger level, the flip-flop is set and the output goes high. If TRIG is above the trigger level and the threshold input (THRES) is above the threshold level, the flip-flop is reset and the output is low. The reset input (RESET) can override all other inputs and can be used to initiate a new timing cycle. If RESET is low, the flip-flop is reset and the output is low. Whenever the output is low, a low-impedance path is provided between the discharge terminal (DISCH) and GND. All unused inputs should be tied to an appropriate logic level to prevent false triggering.

While the CMOS output is capable of sinking over 100 mA and sourcing over 10 mA, the TLC555 exhibits greatly reduced supply-current spikes during output transitions. This minimizes the need for the large decoupling capacitors required by the NE555.

The TLC555 is characterized for operation over the full automotive temperature range of  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ .

### ORDERING INFORMATION<sup>(1)</sup>

$T_A$	$V_{DD}$	PACKAGE <sup>(2)</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
$-40^{\circ}\text{C}$ to $125^{\circ}\text{C}$	5 V to 15 V	SOIC – D	Reel of 2500	TLC555QDRQ1	TLC555Q

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).
- (2) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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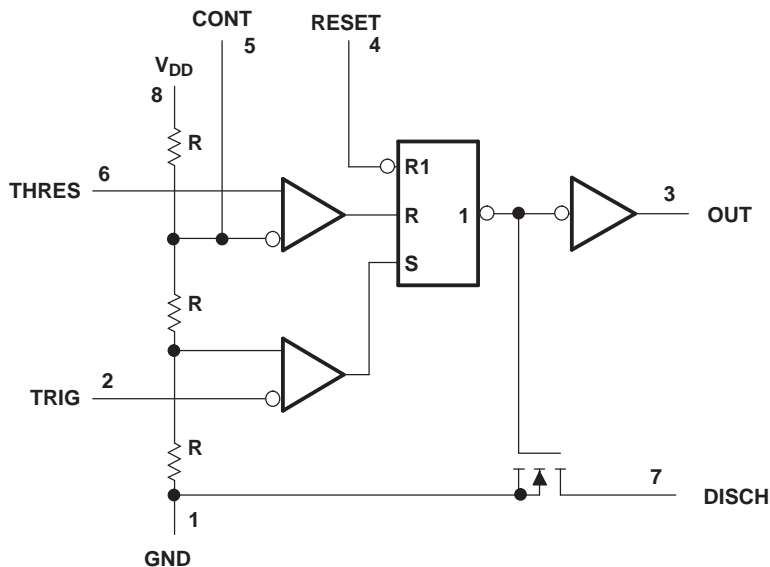
LinCMOS is a trademark of Texas Instruments.

**FUNCTION TABLE**

RESET VOLTAGE <sup>(1)</sup>	TRIGGER VOLTAGE <sup>(1)</sup>	THRESHOLD VOLTAGE <sup>(1)</sup>	OUTPUT	DISCHARGE SWITCH
<MIN	Irrelevant	Irrelevant	L	On
>MAX	<MIN	Irrelevant	H	Off
>MAX	>MAX	>MAX	L	On
>MAX	>MAX	<MIN	As previously established	

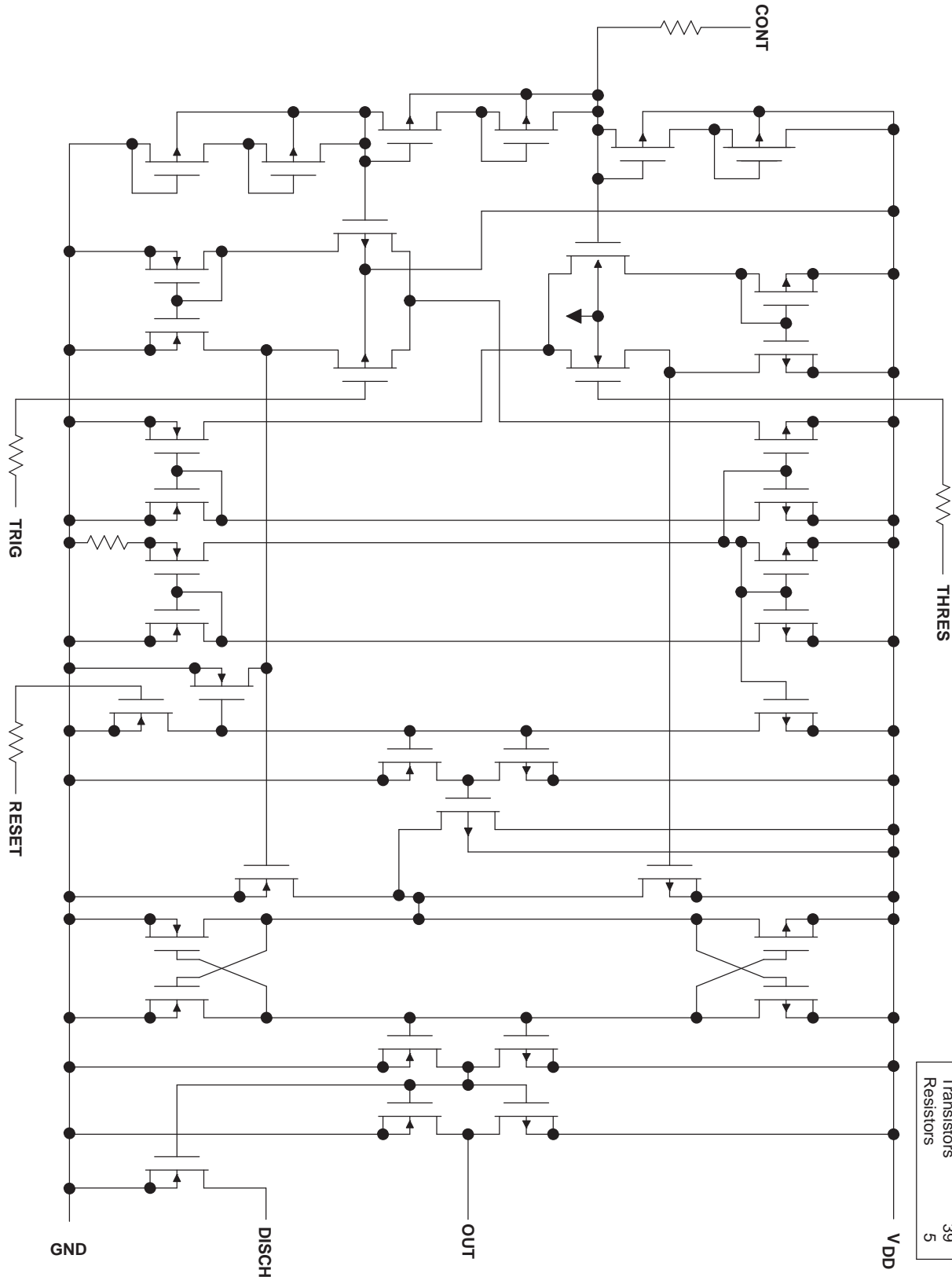
(1) For conditions shown as MIN or MAX, use the appropriate value specified under electrical characteristics.

**FUNCTIONAL BLOCK DIAGRAM**



A. RESET can override TRIG, which can override THRES.

**EQUIVALENT SCHEMATIC**



COMPONENT COUNT	
Transistors	39
Resistors	5

### Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V <sub>DD</sub>	Supply voltage <sup>(2)</sup>		18	V
V <sub>I</sub>	Input voltage range	Any input	-0.3	V <sub>DD</sub>
	Sink current, discharge or output		150	mA
I <sub>O</sub>	Source current, output		15	mA
	Continuous total power dissipation	See Dissipation Rating Table		
T <sub>A</sub>	Operating free-air temperature range	-40	125	°C
T <sub>stg</sub>	Storage temperature range	-65	150	°C
	Lead temperature	1,6 mm (1/16 ch) from case for 10 s	260	°C
	HBM (Human Body Model) ESD		1000	V

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values are with respect to network GND.

### Dissipation Ratings

PACKAGE	T <sub>A</sub> ≤ 25°C POWER RATING	DERATING FACTOR ABOVE T <sub>A</sub> = 25°C	T <sub>A</sub> = 125°C POWER RATING
D	725 mW	5.8 mW/°C	145 mW

### Recommended Operating Conditions

		MIN	MAX	UNIT
V <sub>DD</sub>	Supply voltage	2	15	V
T <sub>A</sub>	Operating free-air temperature	-40	125	°C

## Electrical Characteristics

$V_{DD} = 5\text{ V}$ , at specified free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS	$T_A$ (1)	MIN	TYP	MAX	UNIT
$V_{IT}$	Threshold voltage		25°C	2.8	3.3	3.8	V
			Full range	2.7		3.9	
$I_{IT}$	Threshold current		25°C	10			pA
			MAX	5000			
$V_{I(TRIG)}$	Trigger voltage		25°C	1.36	1.66	1.96	V
			Full range	1.26		2.06	
$I_{I(TRIG)}$	Trigger current		25°C	10			pA
			MAX	5000			
$V_{I(RESET)}$	Reset voltage		25°C	0.4	1.1	1.5	V
			Full range	0.3		1.8	
$I_{I(RESET)}$	Reset current		25°C	10			pA
			MAX	5000			
	Control voltage (open circuit) as a percentage of supply voltage		MAX	66.7			%
	Discharge switch on-state voltage	$I_{OL} = 10\text{ mA}$	25°C		0.14	0.5	V
			Full range			0.6	
	Discharge switch off-state current		25°C	0.1			nA
			MAX	120			
$V_{OH}$	High-level output voltage	$I_{OH} = -1\text{ mA}$	25°C	4.1	4.8		V
			Full range	4.1			
$V_{OL}$	Low-level output voltage	$I_{OL} = 8\text{ mA}$	25°C		0.21	0.4	V
			Full range			0.6	
		$I_{OL} = 5\text{ mA}$	25°C		0.13	0.3	
			Full range			0.45	
		$I_{OL} = 3.2\text{ mA}$	25°C		0.08	0.3	
			Full range			0.4	
$I_{DD}$	Supply current (2)		25°C		170	350	$\mu\text{A}$
			Full range			700	

(1) Full range  $T_A$  is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ .

(2) These values apply for the expected operating configurations in which THRES is connected directly to DISCH or TRIG.

### Electrical Characteristics

$V_{DD} = 15\text{ V}$ , at specified free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS	$T_A$ (1)	MIN	TYP	MAX	UNIT
$V_{IT}$	Threshold voltage		25°C	9.45	10	10.55	V
			Full range	9.35		10.65	
$I_{IT}$	Threshold current		25°C		10		pA
			MAX		5000		
$V_{I(TRIG)}$	Trigger voltage		25°C	4.65	5	5.35	V
			Full range	4.55		5.45	
$I_{I(TRIG)}$	Trigger current		25°C		10		pA
			MAX		5000		
$V_{I(RESET)}$	Reset voltage		25°C	0.4	1.1	1.5	V
			Full range	0.3		1.8	
$I_{I(RESET)}$	Reset current		25°C		10		pA
			MAX		5000		
	Control voltage (open circuit) as a percentage of supply voltage		MAX		66.7		%
	Discharge switch on-state voltage	$I_{OL} = 100\text{ mA}$	25°C		0.77	1.7	V
			Full range			1.8	
	Discharge switch off-state current		25°C		0.1		nA
			MAX		120		
$V_{OH}$	High-level output voltage	$I_{OH} = -10\text{ mA}$	25°C	12.5	14.2		V
			Full range	12.5			
		$I_{OH} = -5\text{ mA}$	25°C	13.5	14.6		
			Full range	13.5			
		$I_{OH} = -1\text{ mA}$	25°C	14.2	14.9		
			Full range	14.2			
$V_{OL}$	Low-level output voltage	$I_{OL} = 100\text{ mA}$	25°C		1.28	3.2	V
			Full range			3.8	
		$I_{OL} = 50\text{ mA}$	25°C		0.63	1	
			Full range			1.5	
		$I_{OL} = 10\text{ mA}$	25°C		0.12	0.3	
			Full range			0.45	
$I_{DD}$	Supply current(2)		25°C		360	600	μA
			Full range			1000	

(1) Full range  $T_A$  is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ .

(2) These values apply for the expected operating configurations in which THRES is connected directly to DISCH or TRIG.

## Operating Characteristics

$V_{DD} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
Initial error of timing interval <sup>(1)</sup>		$V_{DD} = 5\text{ V to }15\text{ V}$ , $C_T = 0.1\ \mu\text{F}$ , $R_A = R_B = 1\ \text{k}\Omega\text{ to }100\ \text{k}\Omega^{(2)}$		1	3	%
Supply voltage sensitivity of timing interval		$V_{DD} = 5\text{ V to }15\text{ V}$ , $C_T = 0.1\ \mu\text{F}$ , $R_A = R_B = 1\ \text{k}\Omega\text{ to }100\ \text{k}\Omega^{(2)}$		0.1	0.5	%/V
$t_r$	Output pulse rise time	$R_L = 10\ \text{M}\Omega$ , $C_L = 10\ \text{pF}$		20	75	ns
$t_f$	Output pulse fall time	$R_L = 10\ \text{M}\Omega$ , $C_L = 10\ \text{pF}$		15	60	ns
$f_{\text{max}}$	Maximum frequency in astable mode	$R_A = 470\ \Omega$ , $C_T = 200\ \text{pF}$ , $R_B = 200\ \Omega^{(2)}$	1.2	2.1		MHz

- (1) Timing interval error is defined as the difference between the measured value and the average value of a random sample from each process run.  
 (2)  $R_A$ ,  $R_B$ , and  $C_T$  are as defined in [Figure 1](#).

## Electrical Characteristics

$V_{DD} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{IT}$	Threshold voltage		2.8	3.3	3.8	V
$I_{IT}$	Threshold current			10		pA
$V_{I(\text{TRIG})}$	Trigger voltage		1.36	1.66	1.96	V
$I_{I(\text{TRIG})}$	Trigger current			10		pA
$V_{I(\text{RESET})}$	Reset voltage		0.4	1.1	1.5	V
$I_{I(\text{RESET})}$	Reset current			10		pA
Control voltage (open circuit) as a percentage of supply voltage				66.7		%
Discharge switch on-state voltage		$I_{OL} = 10\ \text{mA}$		0.14	0.5	V
Discharge switch off-state current				0.1		nA
$V_{OH}$	High-level output voltage	$I_{OH} = -1\ \text{mA}$	4.1	4.8		V
$V_{OL}$	Low-level output voltage	$I_{OL} = 8\ \text{mA}$		0.21	0.4	V
		$I_{OL} = 5\ \text{mA}$		0.13	0.3	
		$I_{OL} = 3.2\ \text{mA}$		0.08	0.3	
$I_{DD}$	Supply current <sup>(1)</sup>			170	350	$\mu\text{A}$

- (1) These values apply for the expected operating configurations in which THRES is connected directly to DISCH or TRIG.

**TYPICAL CHARACTERISTICS**  
**DISCHARGE SWITCH ON-STATE RESISTANCE**  
**vs**  
**FREE-AIR TEMPERATURE**

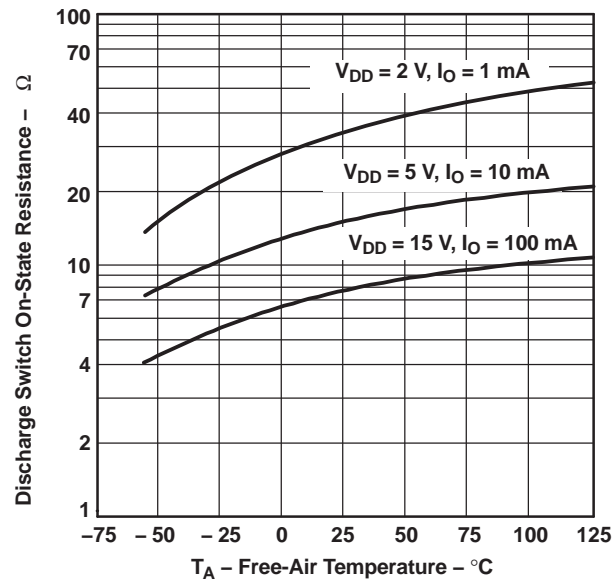
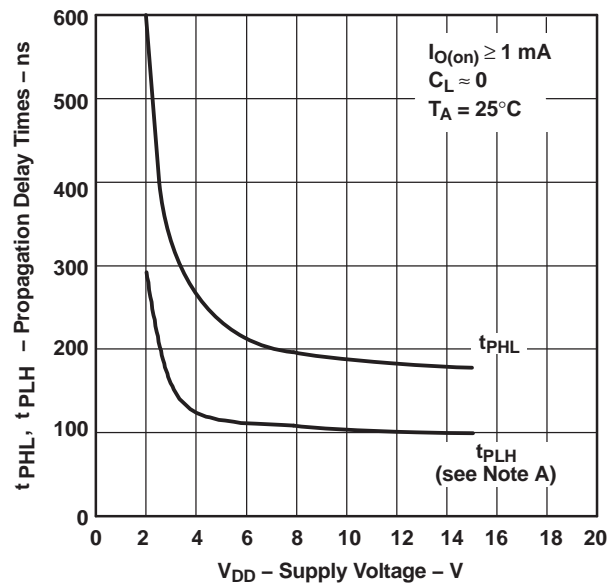


Figure 1.

**PROPAGATION DELAY TIMES TO DISCHARGE**  
**OUTPUT FROM TRIGGER AND THRESHOLD**  
**SHORTED TOGETHER**  
**vs**  
**SUPPLY VOLTAGE**



A. The effects of the load resistance on these values must be taken into account separately.

Figure 2.



## APPLICATION INFORMATION

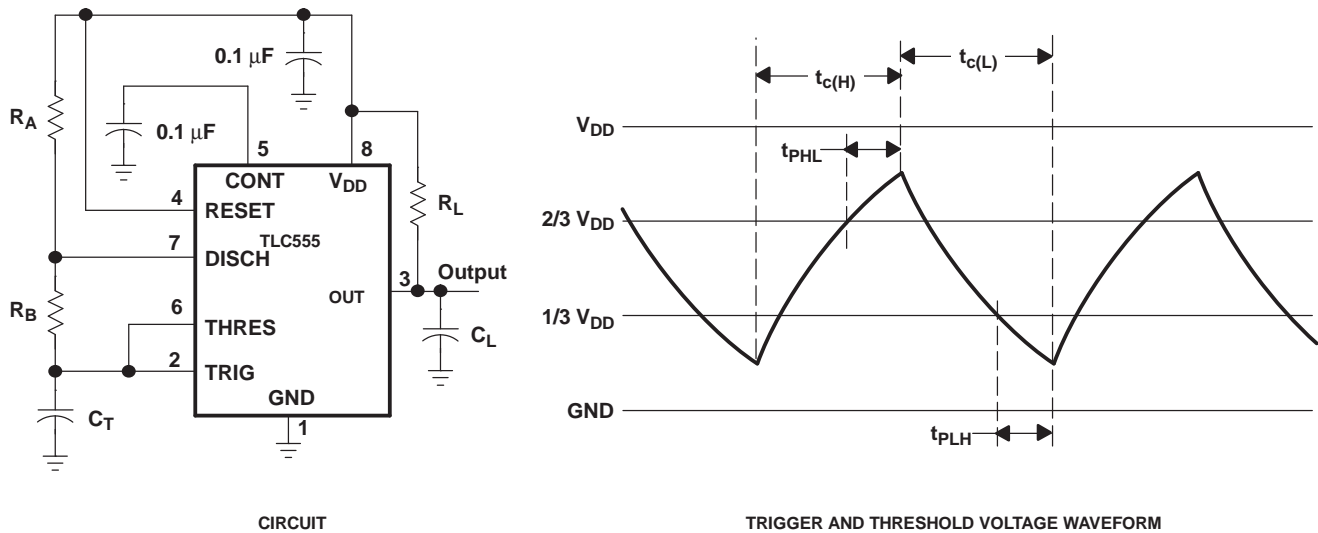


Figure 3. Astable Operation

Connecting TRIG to THRES, as shown in [Figure 3](#), causes the timer to run as a multivibrator. The capacitor  $C_T$  charges through  $R_A$  and  $R_B$  to the threshold voltage level (approximately  $0.67 V_{DD}$ ) and then discharges through  $R_B$  only to the value of the trigger voltage level (approximately  $0.33 V_{DD}$ ). The output is high during the charging cycle ( $t_{c(H)}$ ) and low during the discharge cycle ( $t_{c(L)}$ ). The duty cycle is controlled by the values of  $R_A$ ,  $R_B$ , and  $C_T$  as shown in the following equations.

$$t_{c(H)} \approx C_T (R_A + R_B) \ln 2 \quad (\ln 2 = 0.693)$$

$$t_{c(L)} \approx C_T R_B \ln 2$$

$$\text{Period} = t_{c(H)} + t_{c(L)} \approx C_T (R_A + 2R_B) \ln 2$$

$$\text{Output driver duty cycle} = \frac{t_{c(L)}}{t_{c(H)} + t_{c(L)}} \approx 1 - \frac{R_B}{R_A + 2R_B}$$

$$\text{Output waveform duty cycle} = \frac{t_{c(H)}}{t_{c(H)} + t_{c(L)}} \approx \frac{R_B}{R_A + 2R_B}$$

The 0.1- $\mu\text{F}$  capacitor at CONT in [Figure 3](#) decreases the period by about 10%.

The formulas shown above do not allow for any propagation delay times from the TRIG and THRES inputs to DISCH. These delay times add directly to the period and create differences between calculated and actual values that increase with frequency. In addition, the internal on-state resistance ( $r_{on}$ ) during discharge adds to  $R_B$  to provide another source of timing error in the calculation when  $R_B$  is very low or  $r_{on}$  is very high.

**APPLICATION INFORMATION (continued)**

The following equations provide better agreement with measured values.

$$t_{c(H)} = C_T (R_A + R_B) \ln \left[ 3 - \exp \left( \frac{-t_{PLH}}{C_T (R_B + r_{on})} \right) \right] + t_{PHL}$$

$$t_{c(L)} = C_T (R_B + r_{on}) \ln \left[ 3 - \exp \left( \frac{-t_{PHL}}{C_T (R_A + R_B)} \right) \right] + t_{PLH}$$

These equations and those given previously are similar in that a time constant is multiplied by the logarithm of a number or function. The limit values of the logarithmic terms must be between  $\ln 2$  at low frequencies and  $\ln 3$  at extremely high frequencies. For a duty cycle close to 50%, an appropriate constant for the logarithmic terms

can be substituted with good results. Duty cycles less than 50%  $\frac{t_{c(H)}}{t_{c(H)} + t_{c(L)}}$  require that  $\frac{t_{c(H)}}{t_{c(L)}} < 1$  and possibly  $R_A \leq r_{on}$ . These conditions can be difficult to obtain.

In monostable applications, the trip point on TRIG can be set by a voltage applied to CONT. An input voltage between 10% and 80% of the supply voltage from a resistor divider with at least 500- $\mu$ A bias provides good results.

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
TLC555QDRQ1	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

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**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**OTHER QUALIFIED VERSIONS OF TLC555-Q1 :**

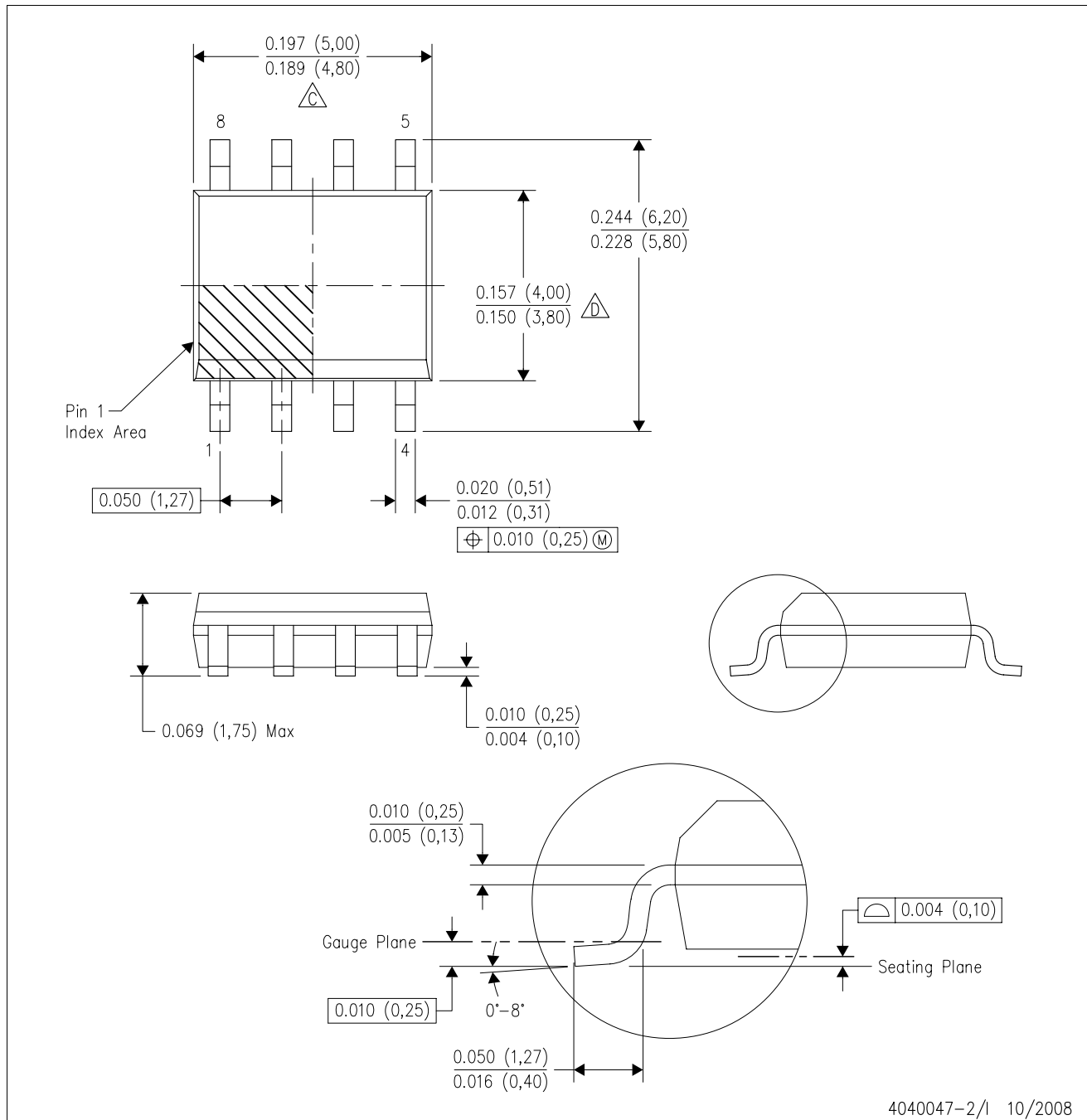
- Catalog: [TLC555](#)
- Military: [TLC555M](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
  - E. Reference JEDEC MS-012 variation AA.

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